

L Number	Hits	Search Text	DB	Time stamp
1	967	(fabry adj perot) or fabry-perot	EPO; JPO; IBM_TDB	2003/01/29 15:46
2	1016834	substrate or film or wafer	EPO; JPO; IBM_TDB	2003/01/29 15:46
3	6	((fabry adj perot) or fabry-perot) and plasma	EPO; JPO; IBM_TDB	2003/01/29 15:46
4	6	(substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma)	EPO; JPO; IBM_TDB	2003/01/29 15:46
5	93839	etch or etching	EPO; JPO; IBM_TDB	2003/01/29 15:46
6	4	((substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma)) and (etch or etching)	EPO; JPO; IBM_TDB	2003/01/29 15:47
-	268	(356/519).CCLS.	USPAT; US-PGPUB	2003/01/23 16:09
-	5185	(fabry adj perot) or fabry-perot	USPAT; US-PGPUB	2003/01/29 15:46
-	158059	plasma	USPAT; US-PGPUB	2003/01/23 16:12
-	831115	substrate or film or wafer	USPAT; US-PGPUB	2003/01/29 15:46
-	580	((fabry adj perot) or fabry-perot) and plasma	USPAT; US-PGPUB	2003/01/29 15:46
-	501	(substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma)	USPAT; US-PGPUB	2003/01/29 15:46
-	161974	etch or etching	USPAT; US-PGPUB	2003/01/29 15:46
-	335	((substrate or film or wafer) and (((fabry adj perot) or fabry-perot) and plasma)) and (etch or etching)	USPAT; US-PGPUB	2003/01/29 15:46
-	11	5225888.URPN.	USPAT	2003/01/23 16:43
-	1	"5907820".PN.	USPAT	2003/01/23 16:56
-	1	"5837094".PN.	USPAT	2003/01/23 16:56
-	1	"5719495".PN.	USPAT	2003/01/23 16:56
-	1	"5656902".PN.	USPAT	2003/01/23 16:57
-	1	"5654796".PN.	USPAT	2003/01/23 16:57
-	138	356/454	USPAT; US-PGPUB	2003/01/28 11:40
-	11	5225888.URPN.	USPAT	2003/01/28 11:49